



### **BAV19WS - BAV21WS**

### SURFACE MOUNT FAST SWITCHING DIODE

#### **Features**

- · Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band, See Page 2
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.004 grams (approximate)



### Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
BAV19WS-7-F	Commercial	SOD323	3000/Tape & Reel
BAV20WS-7-F	Commercial	SOD323	3000/Tape & Reel
BAV21WS-7-F	Commercial	SOD323	3000/Tape & Reel
BAV21WSQ-7-F	Automotive	SOD323	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



XX = Product Type Marking Code BAV19WS Marking: T2 or T3 BAV20WS Marking: T2 or T3 BAV21WS Marking: T3



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	BAV19WS	BAV20WS	BAV21WS	Unit
Repetitive Peak Reverse Voltage		$V_{RRM}$	120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage		$V_{RWM}$ $V_{R}$	100	150	200	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	71	106	141	V
Forward Continuous Current (Note 5)		I <sub>FM</sub>		250		mA
Average Rectified Output Current (Note 5)		Io		200		mA
Non-Repetitive Peak Forward Surge Current @t = 1.0µs @t = 100µs @t = 10ms		I <sub>FSM</sub>	9.0 3.0 1.7		А	
Repetitive Peak Forward Surge Current		I <sub>FRM</sub>	625			mA

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation	$P_{D}$	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

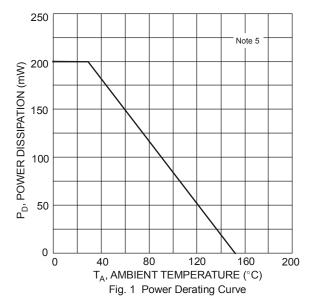
Characteristic		Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	BAV19WS BAV20WS BAV21WS	$V_{(BR)R}$	120 200 250		<b>V</b>	I <sub>R</sub> = 100μA
Forward Voltage		$V_{F}$	_	1.0 1.25	V	I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Peak Reverse Current @ Rated DC Blocking Voltage (Note 6)		I <sub>R</sub>	_	100 15	nΑ μΑ	T <sub>J</sub> = +25°C T <sub>J</sub> = +100°C
Total Capacitance		C <sub>T</sub>	_	5.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time		t <sub>rr</sub>	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

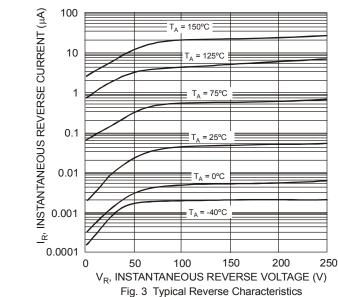
Notes:

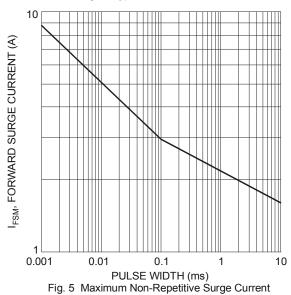
<sup>5.</sup> Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect.









 $I_{\rm F},$  INSTANTANEOUS FORWARD CURRENT (A) 0.1 T<sub>A</sub> = -40°C T<sub>A</sub> = 0°C 0.01 = 25°C = = 125°C T<sub>Δ</sub> = 150°C 0.001 0.2 1.4 0.4 0.6 0.8 1.0 1.2 V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics

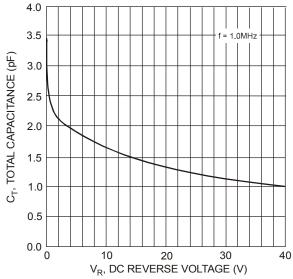
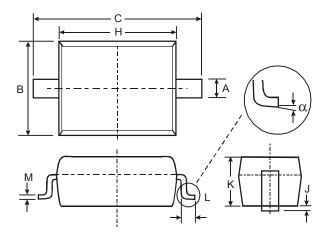


Fig. 4 Total Capacitance vs. Reverse Voltage



# **Package Outline Dimensions**

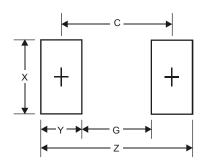
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOD323				
Dim	Min	Max		
Α	0.25	0.35		
В	1.20	1.40		
С	2.30	2.70		
Η	1.60	1.80		
7	0.00	0.10		
K	1.0	1.1		
١	0.20	0.40		
М	0.10	0.15		
α	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Z	3.75		
G	1.05		
Х	0.65		
Y	1.35		
С	2.40		



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